New Product



SiA406DJ Vishay Siliconix

N-Channel 12-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)	
	0.0198 at V _{GS} = 4.5 V	4.5		
12	0.0222 at V _{GS} = 2.5 V	4.5	13.7 nC	
	0.0264 at V _{GS} = 1.8 V	4.5		

2.05 mm

PowerPAK SC-70-6L-Single

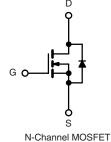
2.05 mm

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- New Thermally Enhanced PowerPAK[®] SC-70 Package
- Small Footprint Area
- Low On-Resistance
- 100 % R_q Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

• Load Switch for Portable Devices



Ordering Information: SiA406DJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

Lot Traceability and Date code

Marking Code

XXX

Part # code

ABSOLUTE MAXIMUM RATINGS	T _A = 25 °C, unles	ss otherwise not	ed		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	12	- v	
Gate-Source Voltage		V _{GS}	± 8		
	T _C = 25 °C		4.5 ^a		
Continuous Drain Current (T _{.1} = 150 °C) ^a	T _C = 70 °C	I _D	4.5 ^a		
Continuous Drain Current $(T_J = 150^{\circ} C)^{\circ}$	T _A = 25 °C	D	4.5 ^{a, b, c}		
	T _A = 70 °C		4.5 ^{a, b, c}	A	
Pulsed Drain Current		I _{DM}	20		
Continuous Source-Drain Diode Current	T _C = 25 °C	I _S	4.5 ^a		
Continuous Source-Drain Diode Ourient	T _A = 25 °C	'S	2.9 ^{b, c}		
	T _C = 25 °C		19		
Maximum Power Dissipation	T _C = 70 °C	P _D	12	w	
Maximum Fower Dissipation	T _A = 25 °C	'D	3.5 ^{b, c}	vv	
	T _A = 70 °C		2.2 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature) ^{d, e}			260		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^{b, f}	t ≤ 5 s	R _{thJA}	28	36	°C/W
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	5.3	6.5	0/11

Notes:

a. Package limited

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under steady state conditions is 80 °C/W.

d. See solder profile (<u>www.vishay.com/ppg?73257</u>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

SiA406DJ

Vishay Siliconix



, unless othe	erwise noted					
Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
			1	1	1	
	$V_{GS} = 0 V, I_D = 250 \mu A$	12			V	
$\Delta V_{DS}/T_{J}$	J		11		- mV/°C	
$\Delta V_{GS(th)}/T_J$	10 - 200 μ.Υ		- 2.9		11107 0	
V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.4		1.0	V	
I _{GSS}	$V_{DS} = 0 V$, $V_{GS} = \pm 8 V$			± 100	nA	
I _{DSS}	$V_{DS} = 12 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μΑ	
	V_{DS} = 12 V, V_{GS} = 0 V, T_{J} = 55 °C			10		
I _{D(on)}	$V_{DS} \le 5 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}$		20		Α	
	V _{GS} = 4.5 V, I _D = 10.8 A		0.0165	0.0198	Ω	
R _{DS(on)}	V _{GS} = 2.5 V, I _D = 10.2 A		0.0185	0.0222		
	$V_{GS} = 1.8 \text{ V}, I_D = 3 \text{ A}$		0.0220	0.0264		
9 _{fs}	V _{DS} = 6 V, I _D = 10.8 A		38		S	
<u> </u>				1		
Ciss			1380		pF	
	$V_{DS} = 6 V, V_{CS} = 0 V, f = 1 MHz$					
	$V_{DS} = 6 V. V_{CS} = 5 V. I_{D} = 10.8 A$			23		
Qg					nC	
Q _{as}	$V_{DS} = 6 V, V_{CS} = 4.5 V, I_{D} = 10.8 A$		2.6			
•			1.1			
-	f = 1 MHz	0.5	2.5	5	Ω	
				20		
. ,	$V_{DD} = 6 V B_1 = 0.7 \Omega$			-	- - - ns	
			-	-		
. ,			-			
	$V_{PP} = 6 V B_{1} = 0.7 \Omega$		-			
· ·				10		
· · ·	T _C = 25 °C			4 5 ^c		
					A	
	$l_{s} = 8.6 \text{ A}$, $V_{cs} = 0 \text{ V}$		0.8		v	
+	· · · · · · · · · · · · · · · · · · ·				ns	
					nC	
-	$I_F = 8.6 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$		8			
t _a						
	$\begin{tabular}{ c c c } \hline Symbol \\ \hline V_{DS} \\ \hline \Delta V_{DS}/T_J \\ \hline \Delta V_{GS}(th)/T_J \\ \hline V_{GS}(th) \\ \hline I_{GSS} \\ \hline I_{DSS} \\ \hline I_{DSS} \\ \hline I_{D(on)} \\ \hline R_{DS(on)} \\ \hline S \\ \hline C_{iss} \\ \hline$	$\begin{tabular}{ c c c c } \hline V_{DS} & V_{GS} = 0 \ V, \ I_{D} = 250 \ \mu A \\ \hline \Delta V_{DS}/T_J & I_D = 250 \ \mu A \\ \hline \Delta V_{GS(th)}/T_J & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A \\ \hline I_{GSS} & V_{DS} = 0 \ V, \ V_{GS} = \pm 8 \ V \\ \hline V_{DS} = 12 \ V, \ V_{GS} = 0 \ V, \ V_{GS} = 5 \ V \\ \hline V_{DS} = 12 \ V, \ V_{GS} = 0 \ V, \ T_J = 55 \ ^{\circ}C \\ \hline I_{D(on)} & V_{DS} \le 5 \ V, \ V_{GS} = 4.5 \ V \\ \hline V_{GS} = 4.5 \ V, \ I_D = 10.8 \ A \\ \hline V_{GS} = 1.8 \ V, \ I_D = 10.8 \ A \\ \hline V_{GS} = 1.8 \ V, \ I_D = 10.8 \ A \\ \hline V_{GS} = 1.8 \ V, \ I_D = 10.8 \ A \\ \hline V_{GS} = 1.8 \ V, \ I_D = 10.8 \ A \\ \hline V_{DS} = 6 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz \\ \hline C_{rss} & V_{DS} = 6 \ V, \ V_{GS} = 5 \ V, \ I_D = 10.8 \ A \\ \hline Q_{g} & V_{DS} = 6 \ V, \ V_{GS} = 5 \ V, \ I_D = 10.8 \ A \\ \hline Q_{gd} & V_{DS} = 6 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 10.8 \ A \\ \hline Q_{gd} & V_{DS} = 6 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 10.8 \ A \\ \hline Q_{gd} & V_{DS} = 6 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 10.8 \ A \\ \hline Q_{gd} & V_{DS} = 6 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 10.8 \ A \\ \hline Q_{gd} & V_{DS} = 6 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 10.8 \ A \\ \hline Q_{gd} & I_D = 8.6 \ A, \ V_{GEN} = 4.5 \ V, \ R_g = 1 \ \Omega \\ \hline I_d \ I_d \ I_d \ I_D = 8.6 \ A, \ V_{GEN} = 8 \ V, \ R_g = 1 \ \Omega \\ \hline I_D = 8.6 \ A, \ V_{GEN} = 8 \ V, \ R_g = 1 \ \Omega \\ \hline I_S & T_C = 25 \ ^{\circ}C \\ \hline I_{SM} & I_S = 8.6 \ A, \ V_{GS} = 0 \ V \\ \hline I_r \ I_D = 8.6 \ A, \ V_{GS} = 0 \ V \\ \hline V_{SD} & I_S = 8.6 \ A, \ V_{GS} = 0 \ V \\ \hline V_{rr} & I_E = 8.6 \ A, \ M/dt = 100 \ A/\mu_S, \ T_1 = 25 \ ^{\circ}C \\ \hline V_{rr} & I_R \ Q_{rr} \ V_{rr} \ V_{r$	$\begin{tabular}{ c c c c c } \hline Symbol & Test Conditions & Min. \\ \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A & 12 \\ \hline \Delta V_{DS}/T_J & I_D = 250 \ \mu A & 0.4 \\ \hline I_D = 250 \ \mu A & 0.4 \\ \hline I_D = 250 \ \mu A & 0.4 \\ \hline V_{GS}(th) & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A & 0.4 \\ \hline I_{GSS} & V_{DS} = 0 \ V, \ V_{GS} = 4.5 \ V & 0.5 \\ \hline V_{DS} = 12 \ V, \ V_{GS} = 0 \ V, \ T_J = 55 \ ^{\circ}C & 0.5 \\ \hline V_{DS} = 12 \ V, \ V_{GS} = 4.5 \ V & 0.5 \\ \hline V_{DS} = 12 \ V, \ V_{GS} = 4.5 \ V & 0.5 \\ \hline V_{DS} = 12 \ V, \ V_{GS} = 4.5 \ V & 0.5 \\ \hline V_{DS} = 12 \ V, \ V_{GS} = 4.5 \ V & 0.5 \\ \hline V_{DS} = 12 \ V, \ V_{GS} = 4.5 \ V & 0.5 \\ \hline V_{DS} = 12 \ V, \ V_{GS} = 10.8 \ A & 0.6 \\ \hline V_{GS} = 1.8 \ V, \ I_D = 10.8 \ A & 0.6 \\ \hline V_{GS} = 1.8 \ V, \ I_D = 10.8 \ A & 0.6 \\ \hline V_{DS} = 6 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz & 0.5 \\ \hline V_{DS} = 6 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 10.8 \ A & 0.6 \\ \hline V_{DS} = 6 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 10.8 \ A & 0.6 \\ \hline V_{DS} = 6 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 10.8 \ A & 0.6 \\ \hline V_{DS} = 6 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 10.8 \ A & 0.6 \\ \hline V_{DS} = 6 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 10.8 \ A & 0.6 \\ \hline V_{DS} = 6 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 10.8 \ A & 0.6 \\ \hline V_{DS} = 6 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 10.8 \ A & 0.6 \\ \hline V_{DS} = 6 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 10.8 \ A & 0.6 \\ \hline V_{DS} = 6 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 10.8 \ A & 0.6 \\ \hline V_{DS} = 6 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 10.8 \ A & 0.6 \\ \hline V_{DD} = 6 \ V, \ R_L = 0.7 \ \Omega & 0.6 \\ \hline V_{DD} = 6 \ V, \ R_L = 0.7 \ \Omega & 0.6 \\ \hline V_{DD} = 6 \ V, \ R_L = 0.7 \ \Omega & 0.6 \\ \hline V_{DD} = 6 \ V, \ R_L = 0.7 \ \Omega & 0.6 \\ \hline V_{DD} = 8.6 \ A, \ V_{GEN} = 8 \ V, \ R_g = 1 \ \Omega & 0.6 \\ \hline V_{DD} = 8.6 \ A, \ V_{GEN} = 8 \ V, \ R_g = 1 \ \Omega & 0.6 \\ \hline V_{DD} = 8.6 \ A, \ V_{GS} = 0 \ V & 0.6 \\ \hline V_{SD} & I_S = 8.6 \ A, \ V_{GS} = 0 \ V & 0.6 \\ \hline V_{SD} & I_S = 8.6 \ A, \ V_{GS} = 0 \ V & 0.6 \\ \hline V_{SD} & I_S = 8.6 \ A, \ V_{GS} = 0 \ V & 0.6 \\ \hline V_{SD} & I_S = 8.6 \ A, \ V_{GS} = 0 \ V & 0.6 \\ \hline V_{SD} & I_S = 8.6 \ A, \ U_{SD} = 10.6 \ A & 0.6 \\ \hline V_{SD} $	$\begin{tabular}{ c c c c c } \hline Symbol & Test Conditions & Min. Typ. \\ \hline V_{DS} & V_{GS} = 0 V, I_D = 250 \ \mu A & 12 & 11 & 11 & 12 & 12 & 11 & 12 & 11 & 12 & 11 & 12 & 11 & 12 & 11 & 12 & 11 & 12 & 0 & 12 & 0 & 0 & 12 & 0 & 0 & 12 & 0 & 0 & 12 & 0 & 0 & 12 & 0 & 0 & 12 & 0 & 0 & 0 & 0 & 0 & 0 & 0 & 0 & 0 & $	$\begin{tabular}{ c c c c c } \hline Symbol & Test Conditions & Min. Typ. Max. \\ \hline V_{DS} & V_{GS} = 0 \ V, \ I_p = 250 \ \mu A & 12 & 11 & \\ \hline V_{GS}(h)/T_J & I_p = 250 \ \mu A & 0.4 & 1.0 & \\ \hline V_{GS}(h)/T_J & V_{DS} = V_{GS}, \ I_p = 250 \ \mu A & 0.4 & 1.0 & \\ \hline V_{GS}(h) & V_{DS} = V_{GS}, \ I_p = 250 \ \mu A & 0.4 & 1.0 & \\ \hline I_{GSS} & V_{DS} = 0 \ V, \ V_{GS} = 4.5 \ V & & 10 & \\ \hline V_{DS} = 12 \ V, \ V_{GS} = 0 \ V, \ T_J = 55 \ ^{\circ}C & 10 & \\ \hline V_{DS} = 12 \ V, \ V_{GS} = 0 \ V, \ T_J = 55 \ ^{\circ}C & & 10 & \\ \hline I_{D}(n) & V_{DS} \le 5 \ V, \ V_{GS} = 4.5 \ V & & 20 & \\ \hline V_{GS} = 1.8 \ V, \ I_p = 10.8 \ A & 0.0165 & 0.0198 & \\ \hline V_{GS} = 1.8 \ V, \ I_p = 10.8 \ A & 0.0165 & 0.0222 & 0.0264 & \\ \hline Q_{GS} & V_{DS} = 6 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz & & 345 & \\ \hline C_{IBS} & V_{DS} = 6 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz & & 345 & \\ \hline C_{IBS} & V_{DS} = 6 \ V, \ V_{GS} = 4.5 \ V, \ I_p = 10.8 \ A & 15.2 & \\ \hline Q_{g} & V_{DS} = 6 \ V, \ V_{GS} = 4.5 \ V, \ I_p = 10.8 \ A & 15.2 & \\ \hline Q_{g} & V_{DS} = 6 \ V, \ V_{GS} = 4.5 \ V, \ I_p = 10.8 \ A & 15.2 & \\ \hline Q_{g} & V_{DS} = 6 \ V, \ V_{GS} = 4.5 \ V, \ I_p = 10.8 \ A & 15.2 & \\ \hline Q_{g} & V_{DS} = 6 \ V, \ V_{GS} = 4.5 \ V, \ I_p = 10.8 \ A & 15.2 & \\ \hline Q_{g} & V_{DS} = 6 \ V, \ V_{GS} = 4.5 \ V, \ I_p = 10.8 \ A & 15.2 & \\ \hline Q_{g} & I_{1.1} & \\ \hline P_{D} = 6 \ V, \ V_{GS} = 4.5 \ V, \ I_p = 10.8 \ A & 1.1 \ \\ \hline P_{D} = 8.6 \ A, \ V_{GEN} = 8 \ V, \ R_g = 1 \ \Omega & 0 \ 20 \ 111 \ 177 \ I_1 \ D = 8.6 \ A, \ V_{GEN} = 8 \ V, \ R_g = 1 \ \Omega & \\ \hline P_{DD} = 6 \ V, \ R_L = 0.7 \ \Omega & \\ \hline I_S & T_C = 25 \ ^{\circ}C & \ 4.5 \ C & \\ \hline I_S & T_C = 25 \ ^{\circ}C & \ 4.5 \ C & \\ \hline I_S & T_C = 25 \ ^{\circ}C & \ 4.5 \ C & \\ \hline I_1 \ I_2 \ I_2 \ I_3 \ I_2 \ I_3 \ I_1 \ I_2 \ I_2 \ I_3 \ I_2 \ I_1$	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Package limited

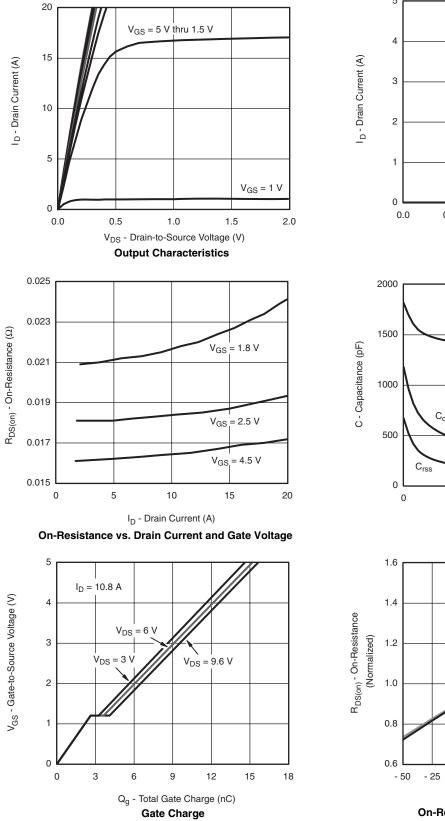
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

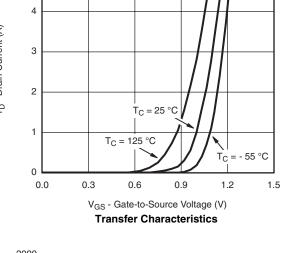
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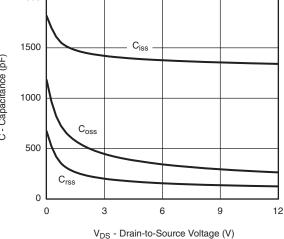


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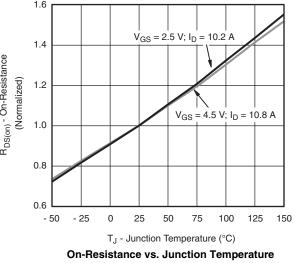
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







Capacitance

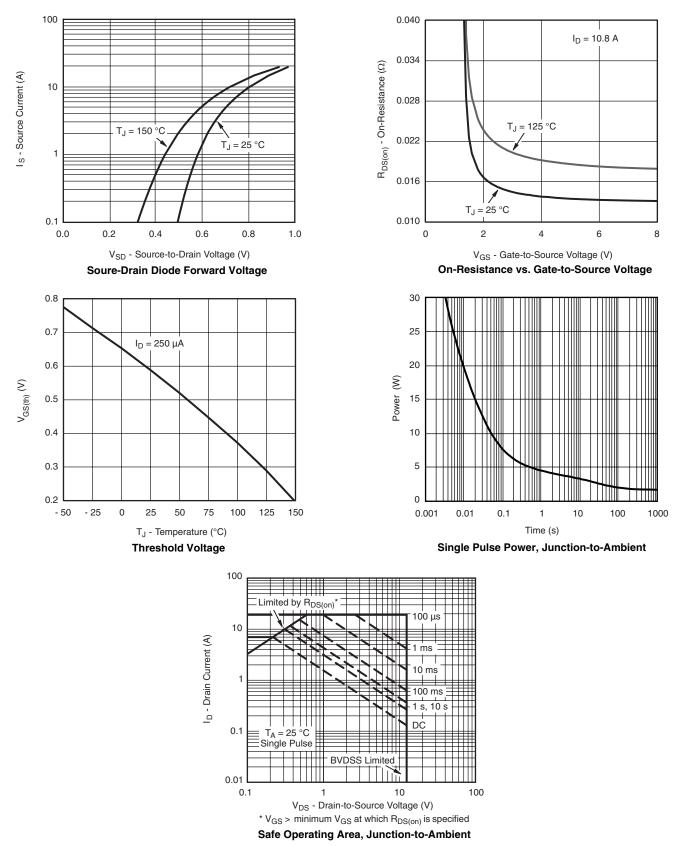


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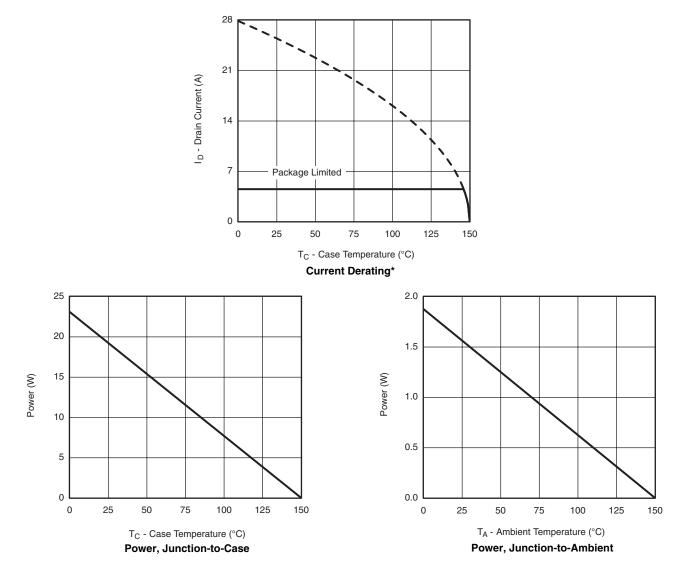
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



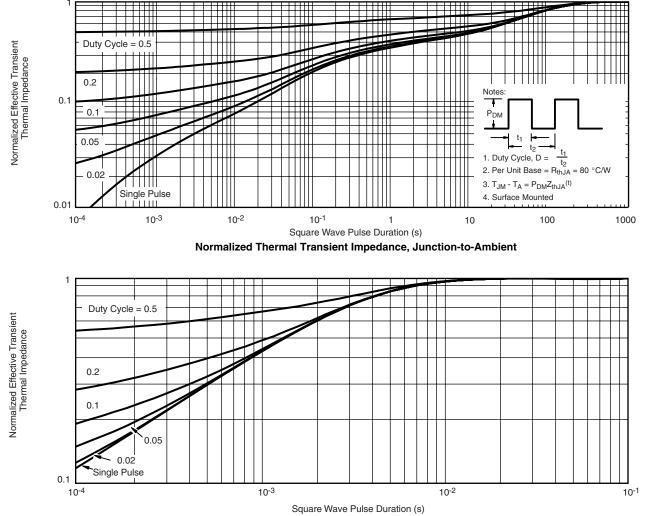
* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg265361.



PowerPAK[®] SC70-6L

VISHA

b PIN2 PIN1 PIN3 _ ₹



b

PIN3

__ ₿

PIN2

PIN1

¥

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¹



RECOMMENDED PAD LAYOUT FOR PowerPAK[®] SC70-6L Single



Dimensions in mm/(Inches)

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Vishay

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Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.